## How electronic heat in graphene spreads and cools

## Klaas-Jan Tielrooij<sup>1</sup>

A. Block<sup>1</sup>, A. Principi<sup>2</sup>, N.C.H. Hesp<sup>3</sup>, A.W. Cummings<sup>1</sup>, M. Liebel<sup>3</sup>, K. Watanabe<sup>4</sup>, T. Taniguchi<sup>5</sup>, S. Roche<sup>1,6</sup>, F.H.L. Koppens<sup>3,6</sup>, N.F. van Hulst<sup>3,6</sup>, E.A.A. Pogna<sup>7,8</sup>, X. Jia<sup>9</sup>, L. Banszerus<sup>10</sup>, J. Zhang<sup>11,12</sup>, X. Liu<sup>11,12</sup>, T. Sohier<sup>13</sup>, S. Forti<sup>14</sup>, K. Soundarapandian<sup>3</sup>, B. Terrés<sup>3</sup>, J.D. Mehew<sup>1</sup>, C. Trovatello<sup>8</sup>, C. Coletti<sup>14,15</sup>, M. Bonn<sup>9</sup>, H.I. Wang<sup>9</sup>, M.J. Verstraete<sup>13</sup>, H. Peng<sup>11,12</sup>, Z. Liu<sup>11,12</sup>, C. Stampfer<sup>10</sup>, G. Cerullo<sup>8</sup>

<sup>1</sup>Catalan Institute for Nanoscience and Nanotechnology, BIST and CSIC, Bellaterra, 08193, Spain

<sup>2</sup>School of Physics and Astronomy, University of Manchester, M13 9PL Manchester, U.K.

<sup>3</sup>ICFO – Institut de Ciències Fotòniques, BIST, Castelldefels, Barcelona 08860, Spain

<sup>4</sup>Research Center for Functional Materials, National Institute for Materials Science, 1-1 Namiki, Tsukuba 305-0044, Japan

<sup>5</sup>International Center for Materials Nanoarchitectonics, National Institute for Materials Science, 1-1 Namiki, Tsukuba 305-0044, Japan

61CREA, Institució Catalana de Recerca i Estudis Avançats, Barcelona, Spain

<sup>7</sup>NEST, Istituto Nanoscienze-CNR and Scuola Normale Superiore, 56127 Pisa, Italy

<sup>8</sup>Department of Physics, Politecnico di Milano, 20133 Milan, Italy

<sup>9</sup>Max-Planck-Institut für Polymerforschung, 55128 Mainz, Germany

<sup>10</sup>JARA-FIT and second Institute of Physics, RWTH Aachen University, 52074 Aachen, Germany, EU

<sup>11</sup>Center for Nanochemistry, College of Chemistry and Molecular Engineering, Academy for

Advanced Interdisciplinary Studies, Peking University, Beijing 100871, China

<sup>12</sup>Beijing Graphene Institute, Beijing 100095, P. R. China

<sup>13</sup>NanoMat/Q-Mat/CESAM, Université de Liège (B5), B-4000 Liège, Belgium

<sup>14</sup>Center for Nanotechnology Innovation IIT@NEST, Piazza San Silvestro 12, 56127 Pisa, Italy

<sup>15</sup>Graphene Laboratories, Via Morego 30, 16163 Genova, Italy

klaas.tielrooij@icn2.cat

The special properties of electronic heat in graphene [1] provide the foundation on which several key optoelectronic device concepts are based, including photodetectors and transceivers for data communication applications [2]. It is thus crucial to understand the heating-cooling dynamics of hot carriers in graphene.

We have studied the cooling dynamics in two high-quality graphene systems which a mobility above 15,000 cm<sup>2</sup>/Vs: WSe<sub>2</sub>-encapsulated graphene and suspended graphene. Our ultrafast pump-probe measurements, combined with theory, indicate that the cooling time at room temperature is intrinsically limited by the coupling of electrons to optical phonons, which form an efficient heat sink even for electrons with initially insufficient kinetic energy for optical phonon emission [3].

We have also studied heat spreading of hot carriers in graphene, using a novel spatiotemporal thermoelectric microscopy technique with femtosecond temporal and nanometer spatial control [4]. When tuning to the hydrodynamic time window before the occurrence of momentum relaxation, and under Dirac-fluid conditions, we observe a giant thermal diffusivity up to 70,000 cm<sup>2</sup>/s. Moreover, the thermal conductivity of the electron system can be larger than the already record-high thermal conductivity of the phonon system of graphene. This result is relevant for thermal management applications.

## References

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